

## **Amendments to the Specification**

Please add after paragraph [023]:

In one embodiment, a fabrication method for multiple LCD panel models from transistor array substrates formed on a common substrate is provided. The method comprises the steps of: selecting areas on the common substrate where switching array substrates of different sizes will be formed; fabricating switching devices using a common set of masks for each of the switching array substrates; forming an alignment layer on each of the transistor array substrates; forming a seal pattern around each of the transistor array substrates; scattering spacers onto each transistor array substrate; attaching the common substrate on which the switching devices are formed to a color filter substrate to form an LCD display panel; cutting the LCD display panel into individual LCD panel models; and disposing liquid crystal in each of the panel models through a liquid crystal injecting hole.

In another embodiment, a fabrication method for multiple transistor array substrates on a common substrate for multiple LCD panel models comprises the steps of: selecting areas on the common substrate where switching array substrates of different sizes will be formed; and fabricating the switching devices for each switching array substrate, regardless of size, through a multiple-mask process that applies the same masks for each switching array substrate.